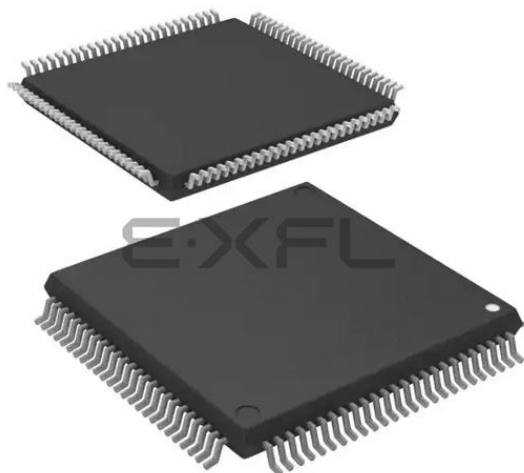




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Last Time Buy
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I ² C, IrDA, SCI, SPI, SSI, USB OTG
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	80
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 17x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51136adfp-30

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications, and Table 1.2 gives a comparison of the functions of the products in different packages.

Table 1.1 is for products with the greatest number of functions, so the number of peripheral modules and channels will differ in accordance with the package type. For details, see Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/3)

Classification	Module/Function	Description
CPU	CPU	- Maximum operating frequency: 32 MHz 32-bit RX CPU - Minimum instruction execution time: One instruction per clock cycle - Address space: 4-Gbyte linear - Register set - General purpose: Sixteen 32-bit registers - Control: Eight 32-bit registers - Accumulator: One 64-bit register - Basic instructions: 73 - DSP instructions: 9 - Addressing modes: 10 - Data arrangement - Instructions: Little endian - Data: Selectable as little endian or big endian - On-chip 32-bit multiplier: 32-bit × 32-bit → 64-bit - On-chip divider: 32-bit ÷ 32-bit → 32 bits - Barrel shifter: 32 bits
Memory	ROM	- Capacity: 128 K /256 K /384 K /512 Kbytes 32 MHz, no-wait memory access - Programming/erasing method: - Serial programming (asynchronous serial communication/USB communication), self-programming
	RAM	- Capacity: 32 K /64 Kbytes 32 MHz, no-wait memory access
	E2 DataFlash	- Capacity: 8 Kbytes - Number of erase/write cycles: 1,000,000 (typ)
MCU operating mode		Single-chip mode
Clock	Clock generation circuit	- Main clock oscillator, sub-clock oscillator, low-speed on-chip oscillator, high-speed on-chip oscillator, PLL frequency synthesizer, USB-dedicated PLL frequency synthesizer, and IWDG-dedicated on-chip oscillator - Oscillation stop detection: Available - Clock frequency accuracy measurement circuit (CAC) - Independent settings for the system clock (ICLK), peripheral module clock (PCLK), and FlashIF clock (FCLK) - The CPU and system sections such as other bus masters run in synchronization with the system clock (ICLK): 32 MHz (at max.) - Peripheral modules run in synchronization with the PCLK: 32 MHz (at max.) - The flash peripheral circuit runs in synchronization with the FCLK: 32 MHz (at max.) - The ICLK frequency can only be set to FCLK, PCLKB, or PCLKD multiplied by n (n: 1, 2, 4, 8, 16, 32, 64).
Resets		RES# pin reset, power-on reset, voltage monitoring reset, independent watchdog timer reset, and software reset
Voltage detection	Voltage detection circuit (LVDAa)	- When the voltage on VCC falls below the voltage detection level, an internal reset or internal interrupt is generated. - Voltage detection circuit 1 is capable of selecting the detection voltage from 10 levels - Voltage detection circuit 2 is capable of selecting the detection voltage from 4 levels
Low power consumption	Low power consumption functions	- Module stop function - Three low power consumption modes - Sleep mode, deep sleep mode, and software standby mode
	Function for lower operating power consumption	- Operating power control modes - High-speed operating mode, middle-speed operating mode, and low-speed operating mode
Interrupt	Interrupt controller (ICUb)	- Interrupt vectors: 120 - External interrupts: 9 (NMI, IRQ0 to IRQ7 pins) - Non-maskable interrupts: 4 (NMI pin, voltage monitoring 1 interrupt, voltage monitoring 2 interrupt, and IWDG interrupt) 16 levels specifiable for the order of priority

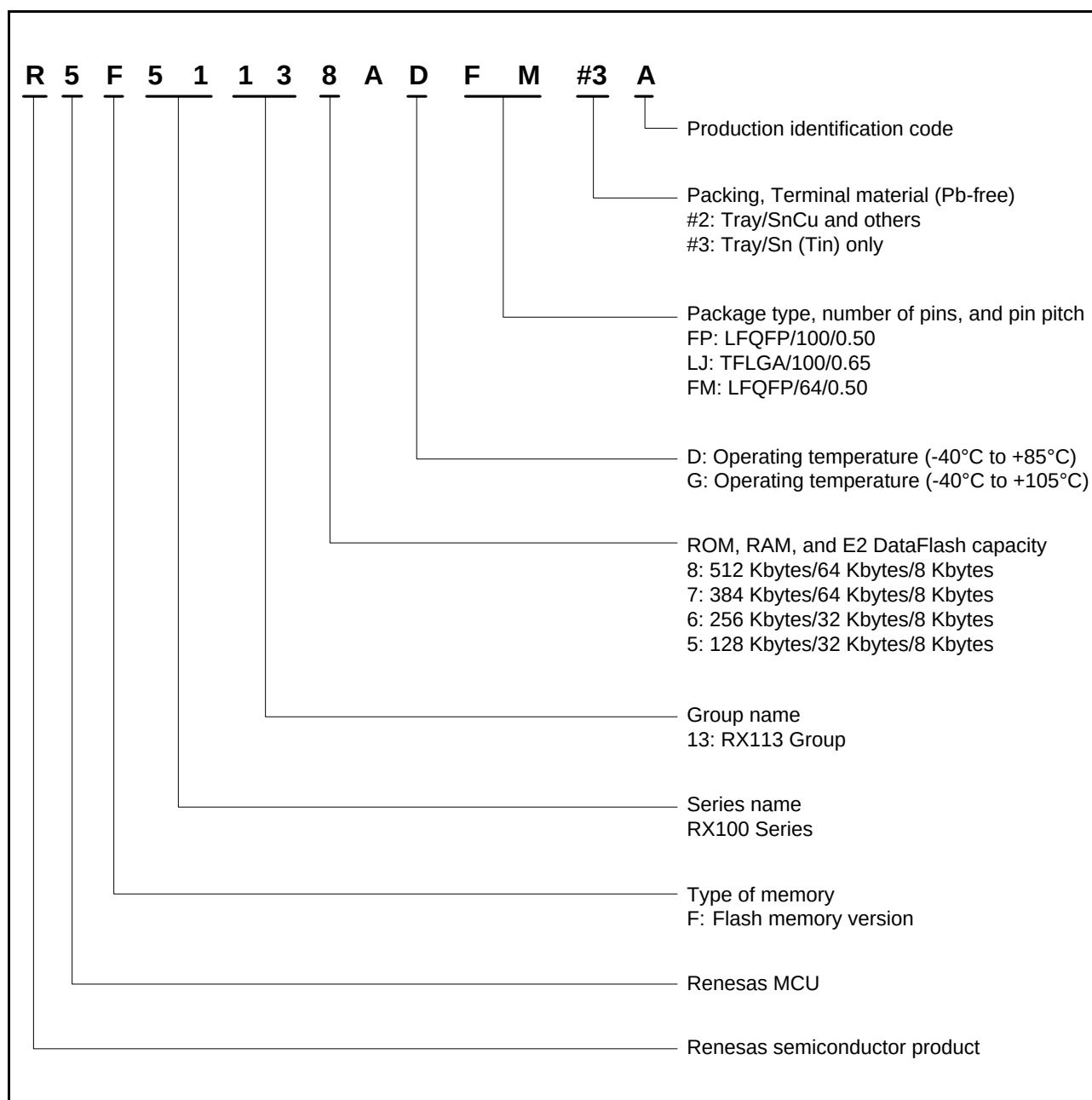


Figure 1.1 How to Read the Product Part No., Memory Capacity, and Package Type

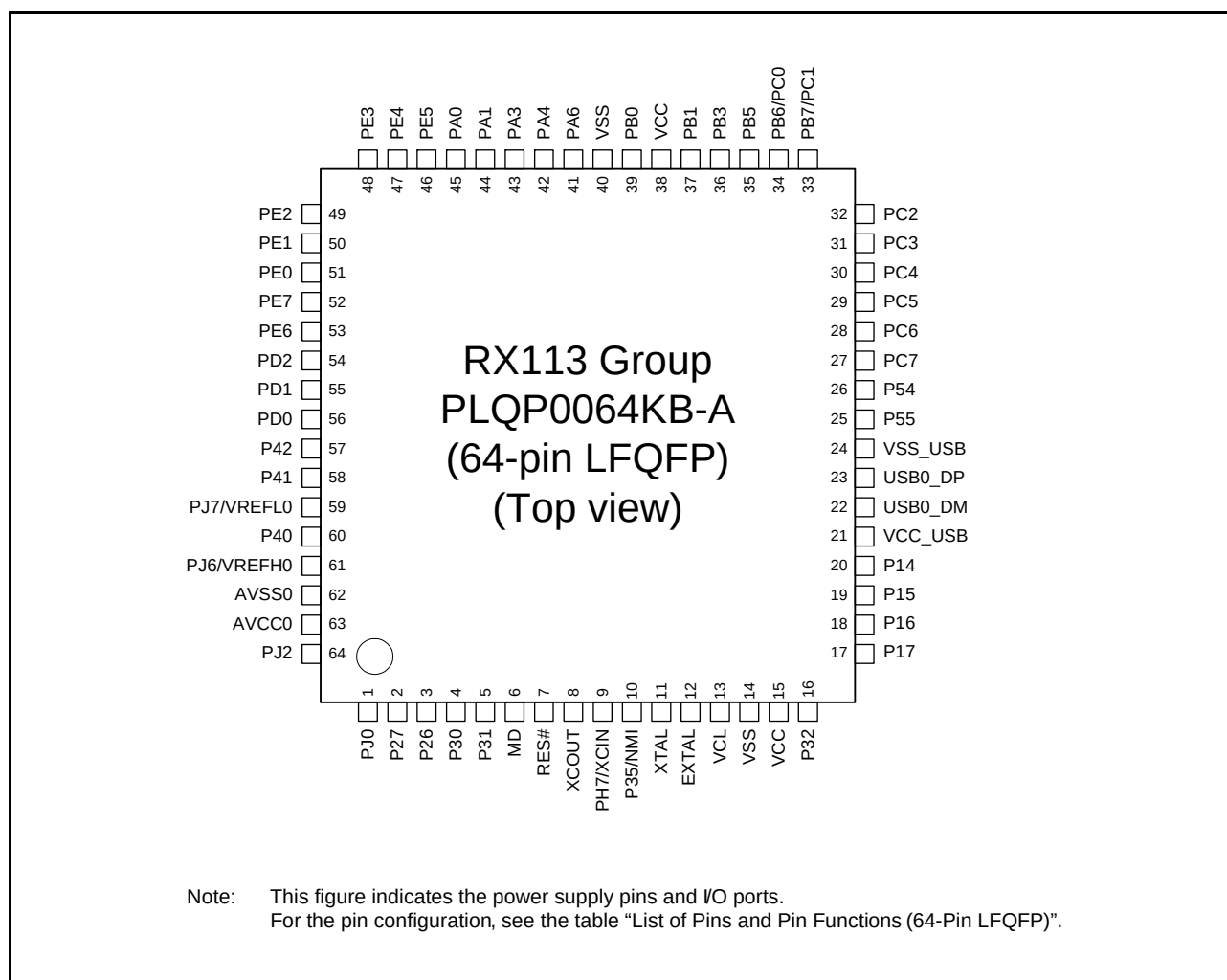


Figure 1.5 Pin Assignments of the 64-Pin LFQFP

Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (3/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC, TMR)	Communication (SCIE, SCIf, RSPI, RiIC, USB, SSI)	LCD, Touch	Others
H1	XTAL					
H2	EXTAL					
H3		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1/RSPCKA		IRQ5/CLKOUT/CACREF
H4		P13	MTIOC0B/TMO3	CTS12#/RTS12#/SS12#/CTS0#/RTS0#/SS0#	SEG00	IRQ3
H5		P11	MTIC5U/POE0#	RXD12/RDX12/SMISO12/SSCL12/RXD0/SMISO0/SSCL0	SEG02	IRQ7
H6		P51	MTIOC4C	RSPCKA/SCK2	SEG07	
H7		PC0	MTIOC3C	CTS5#/RTS5#/SS5#/SSLA1	SEG10	
H8		PC1	MTIOC3A	SCK5/SSLA2	SEG09	
H9		PB6	MTIOC3D	RXD9/SMISO9/SSCL9/SSIRXD0	SEG12/COM5	
H10		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9/SSITXD0	SEG11/COM4	
J1	VCL					
J2		P17	MTIOC0C/MTIOC3A/MTIOC3B/POE8#/TMO1	SCK1/MISOA/SDA0/RXD12/RDX12/SMISO12/SSCL12		IRQ7
J3		P32	MTIOC0C/RTCOUT/TMO3	TXD6/SMOSI6/SSDA6/CTS6#/RTS6#/SS6#	TS11	IRQ2
J4	VCC_USB					
J5	VSS_USB					
J6		P52		MISOA/RXD2/SMISO2/SSCL2	SEG06	
J7		P55	MTIOC4D/TMO3		VL1	
J8		PC7	MTIOC3A/MTCLKB/TMO2	TXD1/SMOSI1/SSDA1/MISOA/TXD8/SMOSI8/SSDA8/USB0_OVRCURB	VL3	CACREF
J9		PC4	MTIOC3D/MTCLKC/POE0#/TMCI1	SSLA0/CTS8#/RTS8#/SS8#/SCK5/USB0_VBUSEN/USB0_VBUS *1	COM1	IRQ2/CLKOUT
J10		PC2	MTIOC4B	RXD5/SMOSI5/SSCL5/IRRXD5/SSLA3	COM3	
K1	VSS					
K2	VDD					
K3		P16	MTIOC3C/MTIOC3D/RTCOUT/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/SCL0/USB0_VBUS/USB0_VBUSEN/USB0_OVRCURB		IRQ6/ADTRG0#
K4				USB0_DM		
K5				USB0_DP		
K6		P53	MTIOC2B	SSLA0/CTS2#/RTS2#/SS2#	SEG05	
K7		P54	MTIOC4B/TMCI1		VL2	
K8		PC6	MTIOC3C/MTCLKA/TMCI2	RXD1/SMISO1/SSCL1/MOSIA/RXD8/SMISO8/SSCL8/USB0_EXICEN	VL4	
K9		PC5	MTIOC3B/MTCLKD/TMRI2	SCK1/RSPCKA/SCK8/USB0_ID	COM0	
K10		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5/IRTXD5	COM2	

Note 1. Not 5 V tolerant.

Note 2. The power source of the I/O buffer for these pins is AVCC0.

Table 4.1 List of I/O Registers (Address Order) (2/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 240Ch	DTC	DTC Module Start Register	DTCST	8	8	2 ICLK
0008 240Eh	DTC	DTC Status Register	DTCSTS	16	16	2 ICLK
0008 7010h	ICU	Interrupt Request Register 016	IR016	8	8	2 ICLK
0008 701Bh	ICU	Interrupt Request Register 027	IR027	8	8	2 ICLK
0008 701Ch	ICU	Interrupt Request Register 028	IR028	8	8	2 ICLK
0008 701Dh	ICU	Interrupt Request Register 029	IR029	8	8	2 ICLK
0008 701Eh	ICU	Interrupt Request Register 030	IR030	8	8	2 ICLK
0008 701Fh	ICU	Interrupt Request Register 031	IR031	8	8	2 ICLK
0008 7020h	ICU	Interrupt Request Register 032	IR032	8	8	2 ICLK
0008 7021h	ICU	Interrupt Request Register 033	IR033	8	8	2 ICLK
0008 7022h	ICU	Interrupt Request Register 034	IR034	8	8	2 ICLK
0008 7024h	ICU	Interrupt Request Register 036	IR036	8	8	2 ICLK
0008 7025h	ICU	Interrupt Request Register 037	IR037	8	8	2 ICLK
0008 7026h	ICU	Interrupt Request Register 038	IR038	8	8	2 ICLK
0008 702Ch	ICU	Interrupt Request Register 044	IR044	8	8	2 ICLK
0008 702Dh	ICU	Interrupt Request Register 045	IR045	8	8	2 ICLK
0008 702Eh	ICU	Interrupt Request Register 046	IR046	8	8	2 ICLK
0008 702Fh	ICU	Interrupt Request Register 047	IR047	8	8	2 ICLK
0008 7039h	ICU	Interrupt Request Register 057	IR057	8	8	2 ICLK
0008 703Ah	ICU	Interrupt Request Register 058	IR058	8	8	2 ICLK
0008 703Bh	ICU	Interrupt Request Register 059	IR059	8	8	2 ICLK
0008 703Ch	ICU	Interrupt Request Register 060	IR060	8	8	2 ICLK
0008 703Dh	ICU	Interrupt Request Register 061	IR061	8	8	2 ICLK
0008 703Eh	ICU	Interrupt Request Register 062	IR062	8	8	2 ICLK
0008 703Fh	ICU	Interrupt Request Register 063	IR063	8	8	2 ICLK
0008 7040h	ICU	Interrupt Request Register 064	IR064	8	8	2 ICLK
0008 7041h	ICU	Interrupt Request Register 065	IR065	8	8	2 ICLK
0008 7042h	ICU	Interrupt Request Register 066	IR066	8	8	2 ICLK
0008 7043h	ICU	Interrupt Request Register 067	IR067	8	8	2 ICLK
0008 7044h	ICU	Interrupt Request Register 068	IR068	8	8	2 ICLK
0008 7045h	ICU	Interrupt Request Register 069	IR069	8	8	2 ICLK
0008 7046h	ICU	Interrupt Request Register 070	IR070	8	8	2 ICLK
0008 7047h	ICU	Interrupt Request Register 071	IR071	8	8	2 ICLK
0008 7058h	ICU	Interrupt Request Register 088	IR088	8	8	2 ICLK
0008 7059h	ICU	Interrupt Request Register 089	IR089	8	8	2 ICLK
0008 705Ah	ICU	Interrupt Request Register 090	IR090	8	8	2 ICLK
0008 705Ch	ICU	Interrupt Request Register 092	IR092	8	8	2 ICLK
0008 705Dh	ICU	Interrupt Request Register 093	IR093	8	8	2 ICLK
0008 7066h	ICU	Interrupt Request Register 102	IR102	8	8	2 ICLK
0008 7067h	ICU	Interrupt Request Register 103	IR103	8	8	2 ICLK
0008 706Ah	ICU	Interrupt Request Register 106	IR106	8	8	2 ICLK
0008 706Ch	ICU	Interrupt Request Register 108	IR108	8	8	2 ICLK
0008 706Dh	ICU	Interrupt Request Register 109	IR109	8	8	2 ICLK
0008 706Eh	ICU	Interrupt Request Register 110	IR110	8	8	2 ICLK
0008 7072h	ICU	Interrupt Request Register 114	IR114	8	8	2 ICLK
0008 7073h	ICU	Interrupt Request Register 115	IR115	8	8	2 ICLK
0008 7074h	ICU	Interrupt Request Register 116	IR116	8	8	2 ICLK
0008 7075h	ICU	Interrupt Request Register 117	IR117	8	8	2 ICLK
0008 7076h	ICU	Interrupt Request Register 118	IR118	8	8	2 ICLK
0008 7077h	ICU	Interrupt Request Register 119	IR119	8	8	2 ICLK
0008 7078h	ICU	Interrupt Request Register 120	IR120	8	8	2 ICLK
0008 7079h	ICU	Interrupt Request Register 121	IR121	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (14/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 A100h	SCI8	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A101h	SCI8	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A102h	SCI8	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A103h	SCI8	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A104h	SCI8	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 A105h	SCI8	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A106h	SCI8	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A107h	SCI8	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A108h	SCI8	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A109h	SCI8	I ² C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A10Ah	SCI8	I ² C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A10Bh	SCI8	I ² C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A10Ch	SCI8	I ² C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A10Dh	SCI8	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 A120h	SCI9	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A121h	SCI9	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A122h	SCI9	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A123h	SCI9	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A124h	SCI9	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 A125h	SCI9	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A126h	SCI9	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A127h	SCI9	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A128h	SCI9	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A129h	SCI9	I ² C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A12Ah	SCI9	I ² C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A12Bh	SCI9	I ² C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A12Ch	SCI9	I ² C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A12Dh	SCI9	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 A500h	SSI0	Control Register	SSICR	32	32	2 or 3 PCLKB
0008 A504h	SSI0	Status Register	SSISR	32	32	2 or 3 PCLKB
0008 A510h	SSI0	FIFO Control Register	SSIFCR	32	32	2 or 3 PCLKB
0008 A514h	SSI0	FIFO Status Register	SSIFSR	32	32	2 or 3 PCLKB
0008 A518h	SSI0	Transmit FIFO Data Register	SSIFTDR	32	32	2 or 3 PCLKB
0008 A51Ch	SSI0	Receive FIFO Data Register	SSIFRDR	32	32	2 or 3 PCLKB
0008 A520h	SSI0	TDM Mode Register	SSITDMR	32	32	2 or 3 PCLKB
0008 B000h	CAC	CAC Control Register 0	CACR0	8	8	2 or 3 PCLKB
0008 B001h	CAC	CAC Control Register 1	CACR1	8	8	2 or 3 PCLKB
0008 B002h	CAC	CAC Control Register 2	CACR2	8	8	2 or 3 PCLKB
0008 B003h	CAC	CAC Interrupt Request Enable Register	CAICR	8	8	2 or 3 PCLKB
0008 B004h	CAC	CAC Status Register	CASTR	8	8	2 or 3 PCLKB
0008 B006h	CAC	CAC Upper-Limit Value Setting Register	CAULVR	16	16	2 or 3 PCLKB
0008 B008h	CAC	CAC Lower-Limit Value Setting Register	CALLVR	16	16	2 or 3 PCLKB
0008 B00Ah	CAC	CAC Counter Buffer Register	CACNTBR	16	16	2 or 3 PCLKB
0008 B080h	DOC	DOC Control Register	DOCR	8	8	2 or 3 PCLKB
0008 B082h	DOC	DOC Data Input Register	DODIR	16	16	2 or 3 PCLKB
0008 B084h	DOC	DOC Data Setting Register	DODSR	16	16	2 or 3 PCLKB
0008 B100h	ELC	Event Link Control Register	ELCR	8	8	2 or 3 PCLKB
0008 B102h	ELC	Event Link Setting Register 1	ELSR1	8	8	2 or 3 PCLKB
0008 B103h	ELC	Event Link Setting Register 2	ELSR2	8	8	2 or 3 PCLKB
0008 B104h	ELC	Event Link Setting Register 3	ELSR3	8	8	2 or 3 PCLKB
0008 B105h	ELC	Event Link Setting Register 4	ELSR4	8	8	2 or 3 PCLKB
0008 B108h	ELC	Event Link Setting Register 7	ELSR7	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (19/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 C191h	MPC	PA1 Pin Function Control Register	PA1PFS	8	8	2 or 3 PCLKB
0008 C192h	MPC	PA2 Pin Function Control Register	PA2PFS	8	8	2 or 3 PCLKB
0008 C193h	MPC	PA3 Pin Function Control Register	PA3PFS	8	8	2 or 3 PCLKB
0008 C194h	MPC	PA4 Pin Function Control Register	PA4PFS	8	8	2 or 3 PCLKB
0008 C195h	MPC	PA5 Pin Function Control Register	PA5PFS	8	8	2 or 3 PCLKB
0008 C196h	MPC	PA6 Pin Function Control Register	PA6PFS	8	8	2 or 3 PCLKB
0008 C197h	MPC	PA7 Pin Function Control Register	PA7PFS	8	8	2 or 3 PCLKB
0008 C198h	MPC	PB0 Pin Function Control Register	PB0PFS	8	8	2 or 3 PCLKB
0008 C199h	MPC	PB1 Pin Function Control Register	PB1PFS	8	8	2 or 3 PCLKB
0008 C19Ah	MPC	PB2 Pin Function Control Register	PB2PFS	8	8	2 or 3 PCLKB
0008 C19Bh	MPC	PB3 Pin Function Control Register	PB3PFS	8	8	2 or 3 PCLKB
0008 C19Ch	MPC	PB4 Pin Function Control Register	PB4PFS	8	8	2 or 3 PCLKB
0008 C19Dh	MPC	PB5 Pin Function Control Register	PB5PFS	8	8	2 or 3 PCLKB
0008 C19Eh	MPC	PB6 Pin Function Control Register	PB6PFS	8	8	2 or 3 PCLKB
0008 C19Fh	MPC	PB7 Pin Function Control Register	PB7PFS	8	8	2 or 3 PCLKB
0008 C1A0h	MPC	PC0 Pin Function Control Register	PC0PFS	8	8	2 or 3 PCLKB
0008 C1A1h	MPC	PC1 Pin Function Control Register	PC1PFS	8	8	2 or 3 PCLKB
0008 C1A2h	MPC	PC2 Pin Function Control Register	PC2PFS	8	8	2 or 3 PCLKB
0008 C1A3h	MPC	PC3 Pin Function Control Register	PC3PFS	8	8	2 or 3 PCLKB
0008 C1A4h	MPC	PC4 Pin Function Control Register	PC4PFS	8	8	2 or 3 PCLKB
0008 C1A5h	MPC	PC5 Pin Function Control Register	PC5PFS	8	8	2 or 3 PCLKB
0008 C1A6h	MPC	PC6 Pin Function Control Register	PC6PFS	8	8	2 or 3 PCLKB
0008 C1A7h	MPC	PC7 Pin Function Control Register	PC7PFS	8	8	2 or 3 PCLKB
0008 C1A8h	MPC	PD0 Pin Function Control Register	PD0PFS	8	8	2 or 3 PCLKB
0008 C1A9h	MPC	PD1 Pin Function Control Register	PD1PFS	8	8	2 or 3 PCLKB
0008 C1AAh	MPC	PD2 Pin Function Control Register	PD2PFS	8	8	2 or 3 PCLKB
0008 C1ABh	MPC	PD3 Pin Function Control Register	PD3PFS	8	8	2 or 3 PCLKB
0008 C1ACh	MPC	PD4 Pin Function Control Register	PD4PFS	8	8	2 or 3 PCLKB
0008 C1B0h	MPC	PE0 Pin Function Control Register	PE0PFS	8	8	2 or 3 PCLKB
0008 C1B1h	MPC	PE1 Pin Function Control Register	PE1PFS	8	8	2 or 3 PCLKB
0008 C1B2h	MPC	PE2 Pin Function Control Register	PE2PFS	8	8	2 or 3 PCLKB
0008 C1B3h	MPC	PE3 Pin Function Control Register	PE3PFS	8	8	2 or 3 PCLKB
0008 C1B4h	MPC	PE4 Pin Function Control Register	PE4PFS	8	8	2 or 3 PCLKB
0008 C1B5h	MPC	PE5 Pin Function Control Register	PE5PFS	8	8	2 or 3 PCLKB
0008 C1B6h	MPC	PE6 Pin Function Control Register	PE6PFS	8	8	2 or 3 PCLKB
0008 C1B7h	MPC	PE7 Pin Function Control Register	PE7PFS	8	8	2 or 3 PCLKB
0008 C1BEh	MPC	PF6 Pin Function Control Register	PF6PFS	8	8	2 or 3 PCLKB
0008 C1BFh	MPC	PF7 Pin Function Control Register	PF7PFS	8	8	2 or 3 PCLKB
0008 C1D0h	MPC	PJ0 Pin Function Control Register	PJ0PFS	8	8	2 or 3 PCLKB
0008 C1D2h	MPC	PJ2 Pin Function Control Register	PJ2PFS	8	8	2 or 3 PCLKB
0008 C1D3h	MPC	PJ3 Pin Function Control Register	PJ3PFS	8	8	2 or 3 PCLKB
0008 C1D6h	MPC	PJ6 Pin Function Control Register	PJ6PFS	8	8	2 or 3 PCLKB
0008 C1D7h	MPC	PJ7 Pin Function Control Register	PJ7PFS	8	8	2 or 3 PCLKB
0008 C290h	SYSTEM	Reset Status Register 0	RSTSR0	8	8	4 or 5 PCLKB
0008 C291h	SYSTEM	Reset Status Register 1	RSTSR1	8	8	4 or 5 PCLKB
0008 C293h	SYSTEM	Main Clock Oscillator Forced Oscillation Control Register	MOFCR	8	8	4 or 5 PCLKB
0008 C297h	SYSTEM	Voltage Monitoring Circuit Control Register	LVCMPCR	8	8	4 or 5 PCLKB
0008 C298h	SYSTEM	Voltage Detection Level Select Register	LVDLVL	8	8	4 or 5 PCLKB
0008 C29Ah	SYSTEM	Voltage Monitoring 1 Circuit Control Register 0	LVD1CR0	8	8	4 or 5 PCLKB
0008 C29Bh	SYSTEM	Voltage Monitoring 2 Circuit Control Register 0	LVD2CR0	8	8	4 or 5 PCLKB
0008 C400h	RTC	64-Hz Counter	R64CNT	8	8	2 or 3 PCLKB
0008 C402h	RTC	Second Counter	RSECCNT	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (22/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
000A 0840h	LCDC	LCD Display Data Register 00	SEG00	8	8	1 or 2 PCLKB
000A 0841h	LCDC	LCD Display Data Register 01	SEG01	8	8	1 or 2 PCLKB
000A 0842h	LCDC	LCD Display Data Register 02	SEG02	8	8	1 or 2 PCLKB
000A 0843h	LCDC	LCD Display Data Register 03	SEG03	8	8	1 or 2 PCLKB
000A 0844h	LCDC	LCD Display Data Register 04	SEG04	8	8	1 or 2 PCLKB
000A 0845h	LCDC	LCD Display Data Register 05	SEG05	8	8	1 or 2 PCLKB
000A 0846h	LCDC	LCD Display Data Register 06	SEG06	8	8	1 or 2 PCLKB
000A 0847h	LCDC	LCD Display Data Register 07	SEG07	8	8	1 or 2 PCLKB
000A 0848h	LCDC	LCD Display Data Register 08	SEG08	8	8	1 or 2 PCLKB
000A 0849h	LCDC	LCD Display Data Register 09	SEG09	8	8	1 or 2 PCLKB
000A 084Ah	LCDC	LCD Display Data Register 10	SEG10	8	8	1 or 2 PCLKB
000A 084Bh	LCDC	LCD Display Data Register 11	SEG11	8	8	1 or 2 PCLKB
000A 084Ch	LCDC	LCD Display Data Register 12	SEG12	8	8	1 or 2 PCLKB
000A 084Dh	LCDC	LCD Display Data Register 13	SEG13	8	8	1 or 2 PCLKB
000A 084Eh	LCDC	LCD Display Data Register 14	SEG14	8	8	1 or 2 PCLKB
000A 084Fh	LCDC	LCD Display Data Register 15	SEG15	8	8	1 or 2 PCLKB
000A 0850h	LCDC	LCD Display Data Register 16	SEG16	8	8	1 or 2 PCLKB
000A 0851h	LCDC	LCD Display Data Register 17	SEG17	8	8	1 or 2 PCLKB
000A 0852h	LCDC	LCD Display Data Register 18	SEG18	8	8	1 or 2 PCLKB
000A 0853h	LCDC	LCD Display Data Register 19	SEG19	8	8	1 or 2 PCLKB
000A 0854h	LCDC	LCD Display Data Register 20	SEG20	8	8	1 or 2 PCLKB
000A 0855h	LCDC	LCD Display Data Register 21	SEG21	8	8	1 or 2 PCLKB
000A 0856h	LCDC	LCD Display Data Register 22	SEG22	8	8	1 or 2 PCLKB
000A 0857h	LCDC	LCD Display Data Register 23	SEG23	8	8	1 or 2 PCLKB
000A 0858h	LCDC	LCD Display Data Register 24	SEG24	8	8	1 or 2 PCLKB
000A 0859h	LCDC	LCD Display Data Register 25	SEG25	8	8	1 or 2 PCLKB
000A 085Ah	LCDC	LCD Display Data Register 26	SEG26	8	8	1 or 2 PCLKB
000A 085Bh	LCDC	LCD Display Data Register 27	SEG27	8	8	1 or 2 PCLKB
000A 085Ch	LCDC	LCD Display Data Register 28	SEG28	8	8	1 or 2 PCLKB
000A 085Dh	LCDC	LCD Display Data Register 29	SEG29	8	8	1 or 2 PCLKB
000A 085Eh	LCDC	LCD Display Data Register 30	SEG30	8	8	1 or 2 PCLKB
000A 085Fh	LCDC	LCD Display Data Register 31	SEG31	8	8	1 or 2 PCLKB
000A 0860h	LCDC	LCD Display Data Register 32	SEG32	8	8	1 or 2 PCLKB
000A 0861h	LCDC	LCD Display Data Register 33	SEG33	8	8	1 or 2 PCLKB
000A 0862h	LCDC	LCD Display Data Register 34	SEG34	8	8	1 or 2 PCLKB
000A 0863h	LCDC	LCD Display Data Register 35	SEG35	8	8	1 or 2 PCLKB
000A 0864h	LCDC	LCD Display Data Register 36	SEG36	8	8	1 or 2 PCLKB
000A 0865h	LCDC	LCD Display Data Register 37	SEG37	8	8	1 or 2 PCLKB
000A 0866h	LCDC	LCD Display Data Register 38	SEG38	8	8	1 or 2 PCLKB
000A 0867h	LCDC	LCD Display Data Register 39	SEG39	8	8	1 or 2 PCLKB
000A 0900h	CTSU	CTSU Control Register 0	CTSUCR0	8	8	1 or 2 PCLKB
000A 0901h	CTSU	CTSU Control Register 1	CTSUCR1	8	8	1 or 2 PCLKB
000A 0902h	CTSU	CTSU Synchronous Noise Reduction Setting Register	CTSUSDPRS	8	8	1 or 2 PCLKB
000A 0903h	CTSU	CTSU Sensor Stabilization Wait Time Register	CTSUSST	8	8	1 or 2 PCLKB
000A 0904h	CTSU	CTSU Measurement Channel Register 0	CTSUMCH0	8	8	1 or 2 PCLKB
000A 0905h	CTSU	CTSU Measurement Channel Register 1	CTSUMCH1	8	8	1 or 2 PCLKB
000A 0906h	CTSU	CTSU Channel Enable Control Register 0	CTSUCHAC0	8	8	1 or 2 PCLKB
000A 0907h	CTSU	CTSU Channel Enable Control Register 1	CTSUCHAC1	8	8	1 or 2 PCLKB
000A 0908h	CTSU	CTSU Channel Transmit/Receive Control Register 0	CTSUCHTRC0	8	8	1 or 2 PCLKB
000A 090Ch	CTSU	CTSU Channel Transmit/Receive Control Register 1	CTSUCHTRC1	8	8	1 or 2 PCLKB
000A 0910h	CTSU	CTSU High-Pass Noise Reduction Control Register	CTSUDCLKC	8	8	1 or 2 PCLKB
000A 0911h	CTSU	CTSU Status Register	CTSUST	8	8	1 or 2 PCLKB

5.2 DC Characteristics

Table 5.3 DC Characteristics (1)Conditions: $2.7\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $2.7\text{ V} \leq \text{AVCC0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	RIIC input pin (except for SMBus, 5 V tolerant)	V_{IH}	$\text{VCC} \times 0.7$	—	5.8	V
	Ports P16, P17, port PA6, port PB0 (5 V tolerant)	V_{IH}	$\text{VCC} \times 0.8$	—	5.8	
	Ports P02, P04, P07, ports P10 to P15, ports P20 to P27, ports P30 to P32, P35, ports P50 to P56, ports PA0 to PA5, PA7, ports PB1 to PB7, ports PC0 to PC7, ports PD0 to PD4, ports PE0 to PE7, ports PF6, PF7, port PH7, ports PJ0*1, PJ2*1, PJ3, RES#	V_{IH}	$\text{VCC} \times 0.8$	—	$\text{VCC} + 0.3$	
	RIIC input pin (except for SMBus)	V_{IL}	-0.3	—	$\text{VCC} \times 0.3$	
	Other than RIIC input pin	V_{IL}	-0.3	—	$\text{VCC} \times 0.2$	
	RIIC input pin (except for SMBus)	$\Delta\text{V}_{\text{T}}$	$\text{VCC} \times 0.05$	—	—	
	Other than RIIC input pin	$\Delta\text{V}_{\text{T}}$	$\text{VCC} \times 0.1$	—	—	
Input voltage (except for Schmitt trigger input pins)	MD	V_{IH}	$\text{VCC} \times 0.9$	—	$\text{VCC} + 0.3$	V
	XTAL (external clock input)	V_{IH}	$\text{VCC} \times 0.8$	—	$\text{VCC} + 0.3$	
	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	V_{IH}	$\text{AVCC0} \times 0.7$	—	$\text{AVCC0} + 0.3$	
	RIIC input pin (SMBus)	V_{IH}	2.1	—	$\text{VCC} + 0.3$	
	MD	V_{IL}	-0.3	—	$\text{VCC} \times 0.1$	
	XTAL (external clock input)	V_{IL}	-0.3	—	$\text{VCC} \times 0.2$	
	Ports P40 to P44, P46, ports P90 to P92, ports PJ6, PJ7	V_{IL}	-0.3	—	$\text{AVCC0} \times 0.3$	
	RIIC input pin (SMBus)	V_{IL}	-0.3	—	0.8	

Note 1. There are restrictions on AVCC0 and VCC depending on the usage conditions for the 12-bit D/A converter and I/O ports. When using ports PJ0 and PJ2 multiplexed with DA0 and DA1 as general I/O ports, make sure that $\text{VCC} \leq \text{AVCC0}$.

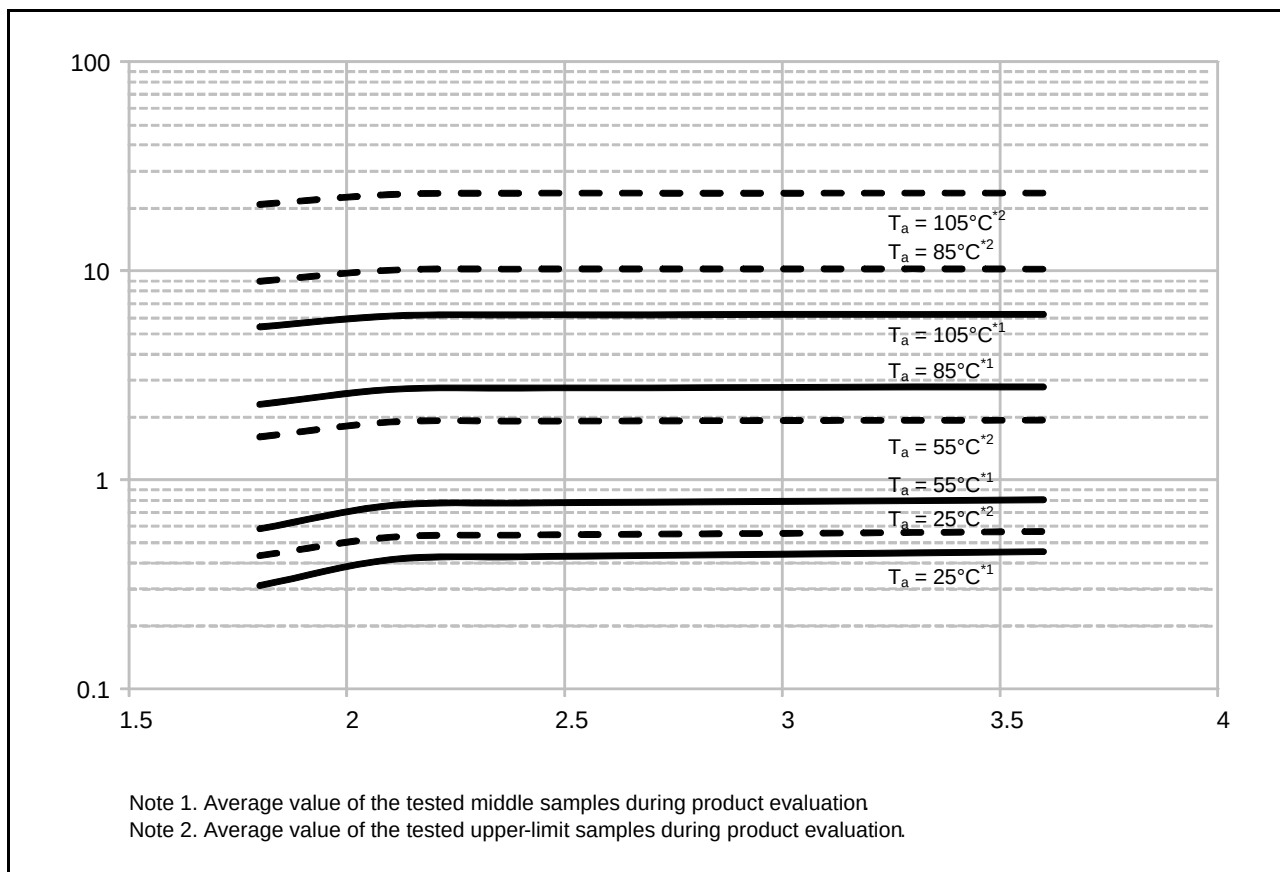


Figure 5.4 Voltage Dependency in Software Standby Mode (Reference Data)

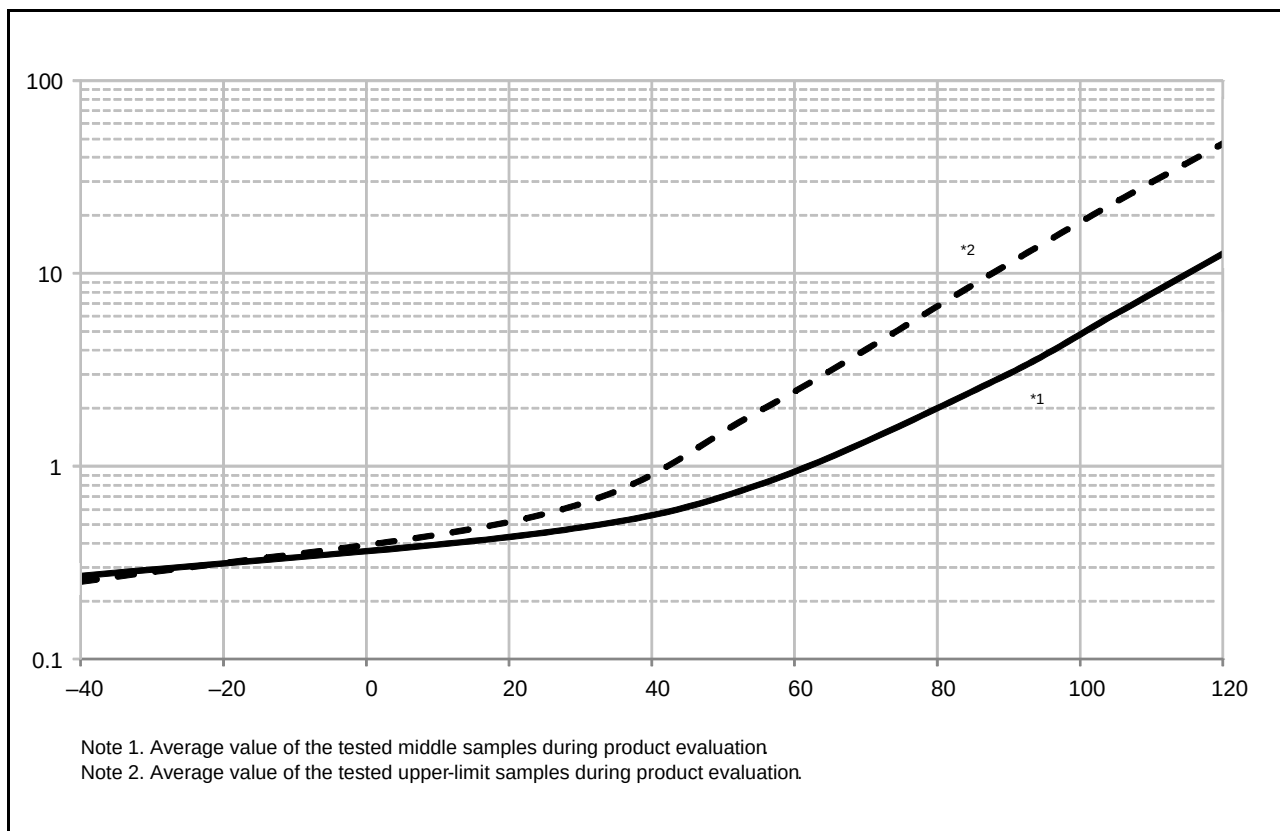


Figure 5.5 Temperature Dependency in Software Standby Mode (Reference Data)

5.3 AC Characteristics

5.3.1 Clock Timing

Table 5.19 Operation Frequency Value (High-Speed Operating Mode)

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVCC0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	16	32	32	MHz
	FlashIF clock (FCLK)*1, *2		8	16	32	32	
	Peripheral module clock (PCLKB)		8	16	32	32	
	Peripheral module clock (PCLKD)*3		8	16	32	32	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note 2. The frequency accuracy of FCLK should be $\pm 3.5\%$. Confirm the frequency accuracy of the clock source.

Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.

Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.20 Operation Frequency Value (Middle-Speed Operating Mode)

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVCC0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	12	12	12	MHz
	FlashIF clock (FCLK)*1, *2		8	12	12	12	
	Peripheral module clock (PCLKB)		8	12	12	12	
	Peripheral module clock (PCLKD)*3		8	12	12	12	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note 2. The frequency accuracy of FCLK should be $\pm 3.5\%$.

Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.

Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.21 Operation Frequency Value (Low-Speed Operating Mode)

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVCC0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	VCC			Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	
Maximum operating frequency	System clock (ICLK)	f _{max}	32.768			kHz
	FlashIF clock (FCLK)*1		32.768			
	Peripheral module clock (PCLKB)		32.768			
	Peripheral module clock (PCLKD)*2		32.768			

Note 1. Programming and erasing the flash memory is impossible.

Note 2. The A/D converter cannot be used.

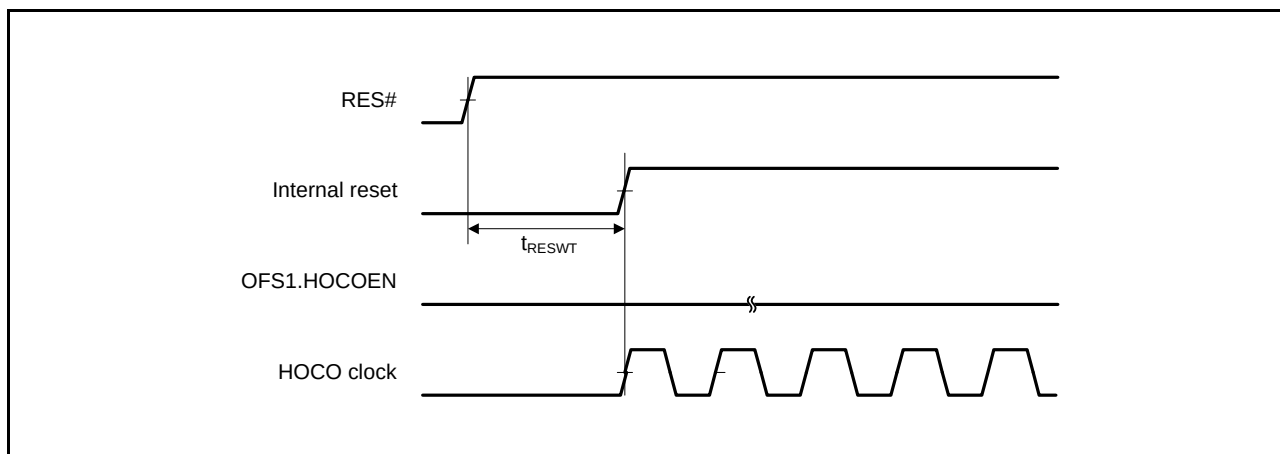


Figure 5.22 HOCO Clock Oscillation Start Timing (After Reset is Canceled by Setting OFS1.HOCOEN Bit to 0)

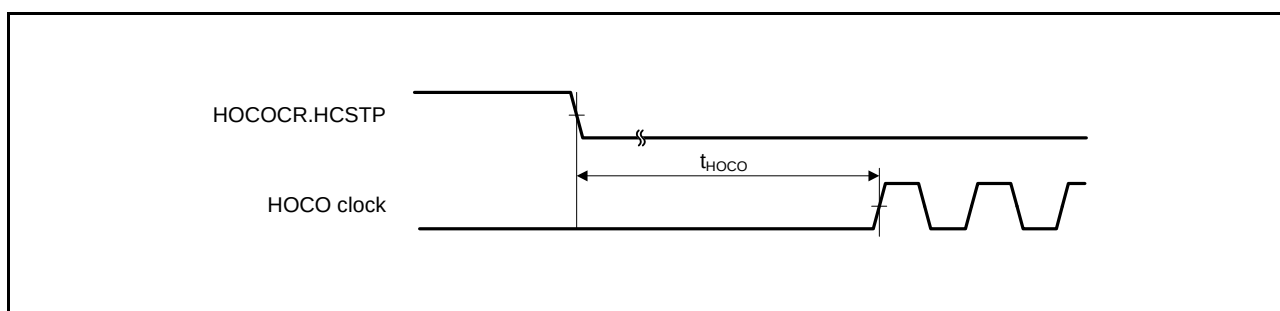


Figure 5.23 HOCO Clock Oscillation Start Timing (Oscillation is Started by Setting HOCOCR.HCSTP Bit)

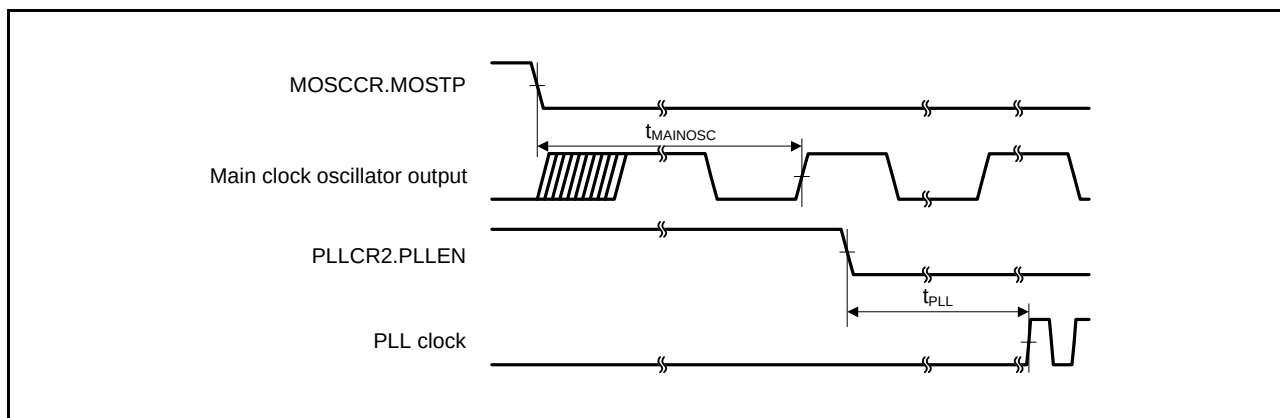


Figure 5.24 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Settled)

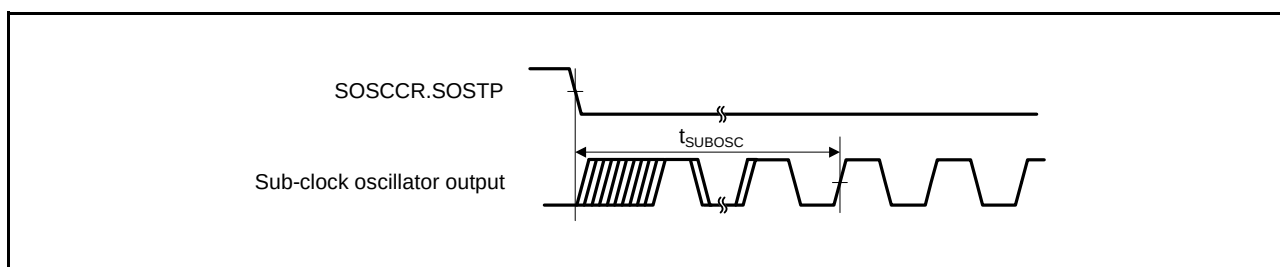


Figure 5.25 Sub-Clock Oscillation Start Timing

5.5 A/D Conversion Characteristics

Table 5.37 A/D Conversion Characteristics (1)

Conditions: $2.7\text{ V} \leq VCC = VCC_USB \leq 3.6\text{ V}$, $2.7\text{ V} \leq AVCC0 \leq 3.6\text{ V}$, $2.7\text{ V} \leq VREFH0 \leq AVCC0$,
 $VSS = AVSS0 = VREFL0 = VSS_USB = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		4	—	32	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 32 MHz)	Permissible signal source impedance (Max.) = 0.3 kΩ	1.031 (0.313)*2	—	—	μs	High-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 09h
		1.375 (0.641)*2	—	—	μs	Normal-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±4.5	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±6.0	LSB	Other than above
Full-scale error		—	±0.75	±4.5	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±6.0	LSB	Other than above
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±1.25	±5.0	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±8.0	LSB	Other than above
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.0	±3.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

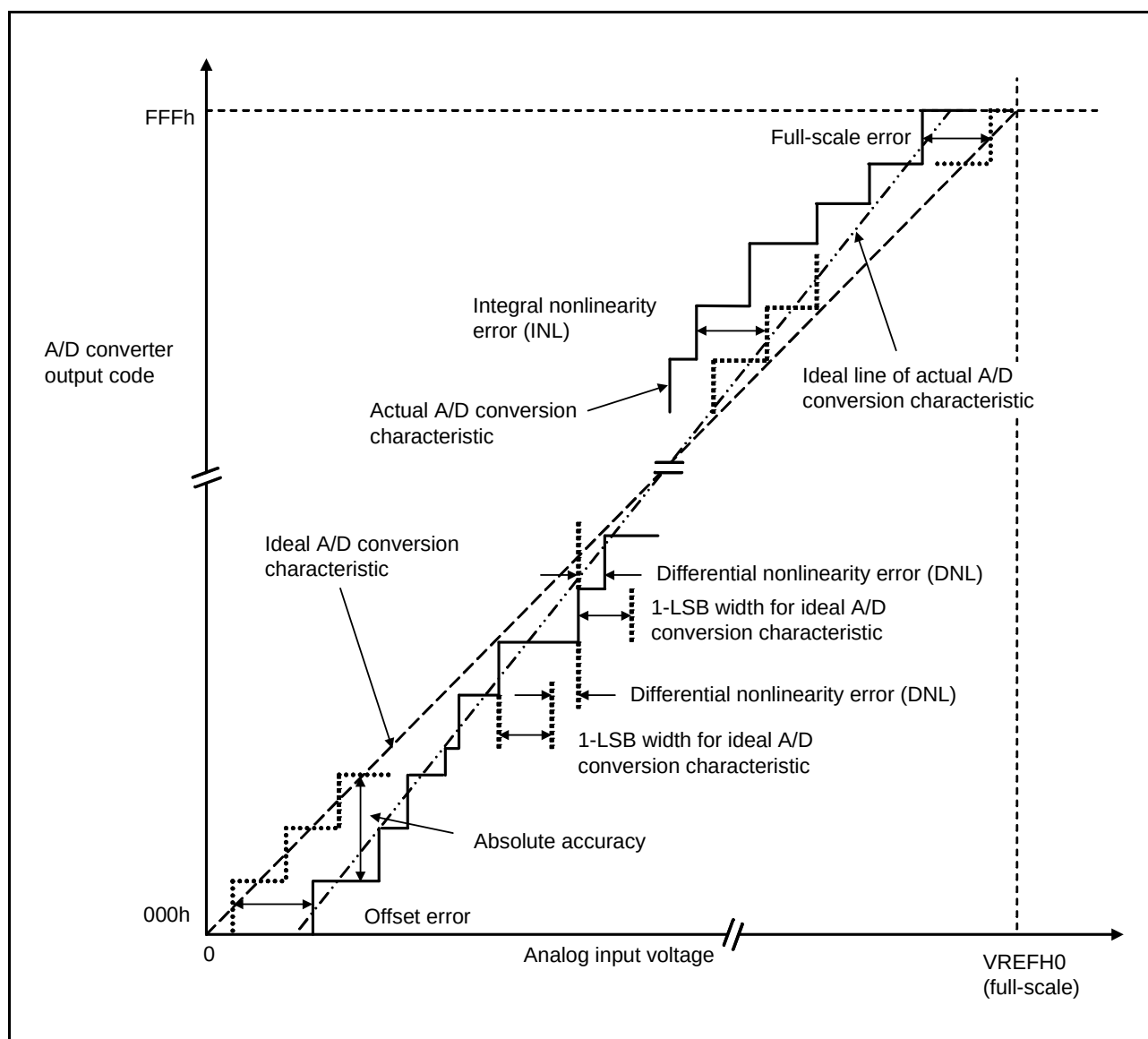


Figure 5.57 Illustration of A/D Converter Characteristic Terms

Absolute accuracy

Absolute accuracy is the difference between output code based on the theoretical A/D conversion characteristics, and the actual A/D conversion result. When measuring absolute accuracy, the voltage at the midpoint of the width of analog input voltage (1-LSB width), that can meet the expectation of outputting an equal code based on the theoretical A/D conversion characteristics, is used as an analog input voltage. For example, if 12-bit resolution is used and if reference voltage ($V_{REFH0} = 3.072 \text{ V}$), then 1-LSB width becomes 0.75 mV, and 0 mV, 0.75 mV, 1.5 mV, ... are used as analog input voltages.

If analog input voltage is 6 mV, absolute accuracy = $\pm 5 \text{ LSB}$ means that the actual A/D conversion result is in the range of 003h to 00Dh though an output code, 008h, can be expected from the theoretical A/D conversion characteristics.

Integral nonlinearity error (INL)

Integral nonlinearity error is the maximum deviation between the ideal line when the measured offset and full-scale errors are zeroed, and the actual output code.

Differential nonlinearity error (DNL)

Differential nonlinearity error is the difference between 1-LSB width based on the ideal A/D conversion characteristics and the width of the actual output code.

Offset error

Offset error is the difference between a transition point of the ideal first output code and the actual first output code.

Full-scale error

Full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

5.11 Power-On Reset Circuit and Voltage Detection Circuit Characteristics

Table 5.57 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (1)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVCC0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V _{POR}	1.35	1.50	1.65	V	Figure 5.62, Figure 5.63
	Voltage detection circuit (LVD1)*1	V _{det1_4}	3.00	3.10	3.20	V	Figure 5.64 At falling edge VCC
		V _{det1_5}	2.91	3.00	3.09		
		V _{det1_6}	2.81	2.90	2.99		
		V _{det1_7}	2.70	2.79	2.88		
		V _{det1_8}	2.60	2.68	2.76		
		V _{det1_9}	2.50	2.58	2.66		
		V _{det1_A}	2.40	2.48	2.56		
		V _{det1_B}	1.99	2.06	2.13		
		V _{det1_C}	1.90	1.96	2.02		
		V _{det1_D}	1.80	1.86	1.92		

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD2), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. n in the symbol $V_{\text{det1_n}}$ denotes the value of the LVDLVL.R.LVD1LVL[3:0] bits.

Table 5.58 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (2)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVCC0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Voltage detection circuit (LVD2)*1	V _{det2_0}	2.71	2.90	3.09	V	Figure 5.65 At falling edge VCC
		V _{det2_1}	2.43	2.60	2.77		
		V _{det2_2}	1.87	2.00	2.13		
		V _{det2_3} *2	1.69	1.80	1.91		
Wait time after power-on reset cancellation	At normal startup*3	t _{POR}	—	9.1	—	ms	Figure 5.63
	During fast startup time*4	t _{POR}	—	1.6	—		
Wait time after voltage monitoring 1 reset cancellation	Power-on voltage monitoring 1 reset disabled*3	t _{LVD1}	—	568	—	μs	Figure 5.64
	Power-on voltage monitoring 1 reset enabled*4		—	100	—		
Wait time after voltage monitoring 2 reset cancellation		t _{LVD2}	—	100	—	μs	Figure 5.65
Response delay time		t _{det}	—	—	350	μs	Figure 5.62
Minimum VCC down time*5		t _{VOFF}	350	—	—	μs	Figure 5.62, VCC = 1.0 V or above
Power-on reset enable time		t _W (POR)	1	—	—	ms	Figure 5.63, VCC = below 1.0 V
LVD operation stabilization time (after LVD is enabled)		T _d (E-A)	—	—	300	μs	Figure 5.64, Figure 5.65
Hysteresis width (LVD1 and LVD2)		V _{LVH}	—	70	—	mV	Vdet1_4 selected
			—	60	—		Vdet1_5 to 9, LVD2 selected
			—	50	—		When selection is from among Vdet1_A to B.
			—	40	—		When selection is from among Vdet1_C to D.

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD1), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. n in the symbol $V_{\text{det2_n}}$ denotes the value of the LVDLVL.R.LVD2LVL[3:0] bits.

Note 2. $V_{\text{det2_3}}$ selection can be used only when the CMPA2 pin input voltage is selected and cannot be used when the power supply voltage (VCC) is selected.

Note 3. When $\text{OFS1}(\text{STUPLVD1REN}, \text{FASTSTUP}) = 11\text{b}$.

Note 4. When $\text{OFS1}(\text{STUPLVD1REN}, \text{FASTSTUP}) \neq 11\text{b}$.

Note 5. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR} , V_{det0} , V_{det1} , and V_{det2} for the POR/LVD.

5.15 Usage Notes

5.15.1 Connecting VCL Capacitor and Bypass Capacitors

This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU to adjust automatically to the optimum level. A 4.7- μ F capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and VSS pin. Figure 5.67 to Figure 5.68 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin. Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor to the MCU power supply pins as close as possible. Use a recommended value of 0.1 μ F as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 36, 12-Bit A/D Converter (S12ADb) in the User's Manual: Hardware.

For notes on designing the printed circuit board, see the descriptions of the application note "Hardware Design Guide" (R01AN1411EJ). The latest version can be downloaded from Renesas Electronics Website.

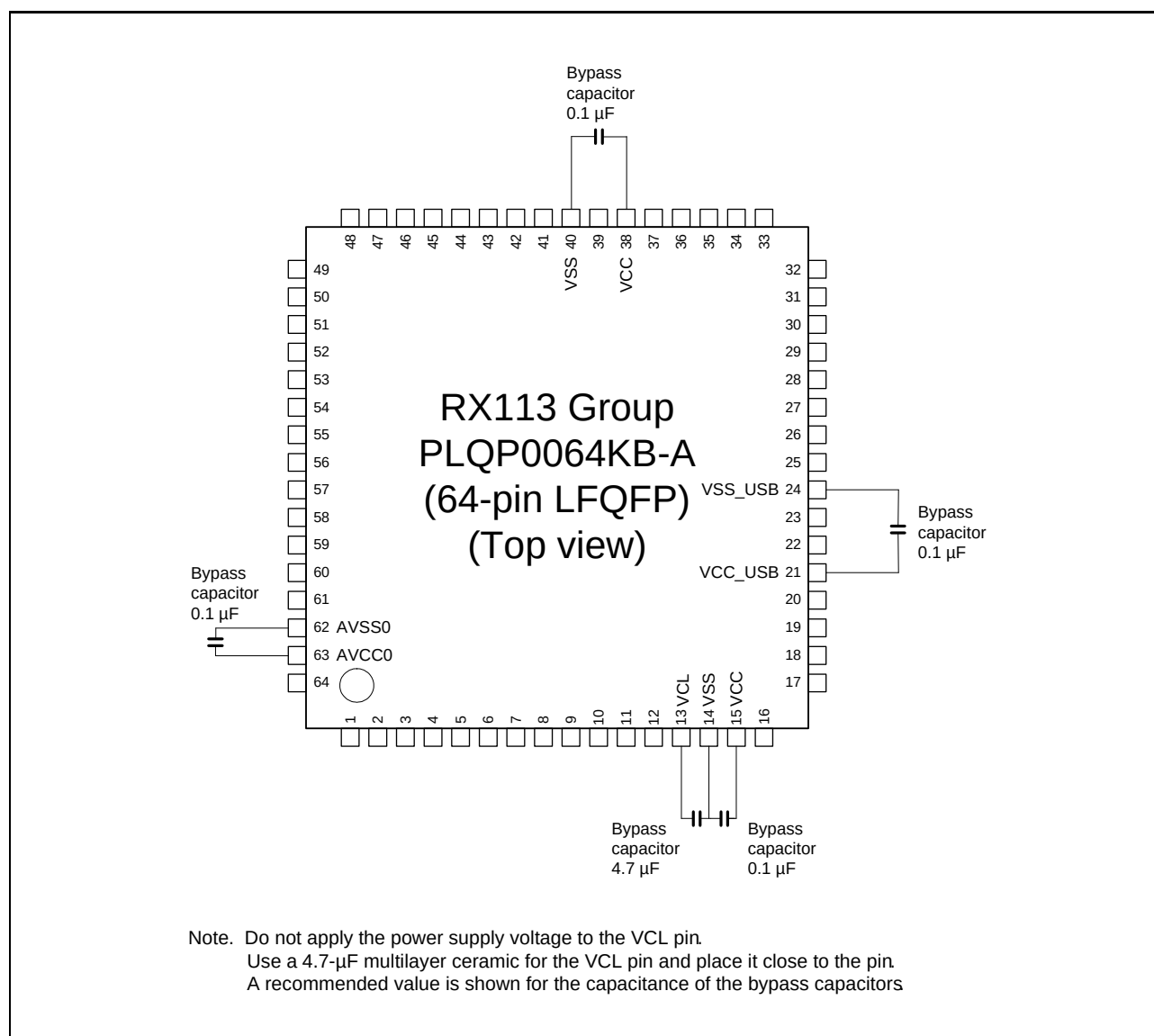


Figure 5.68 Connecting Capacitors (64 Pins)

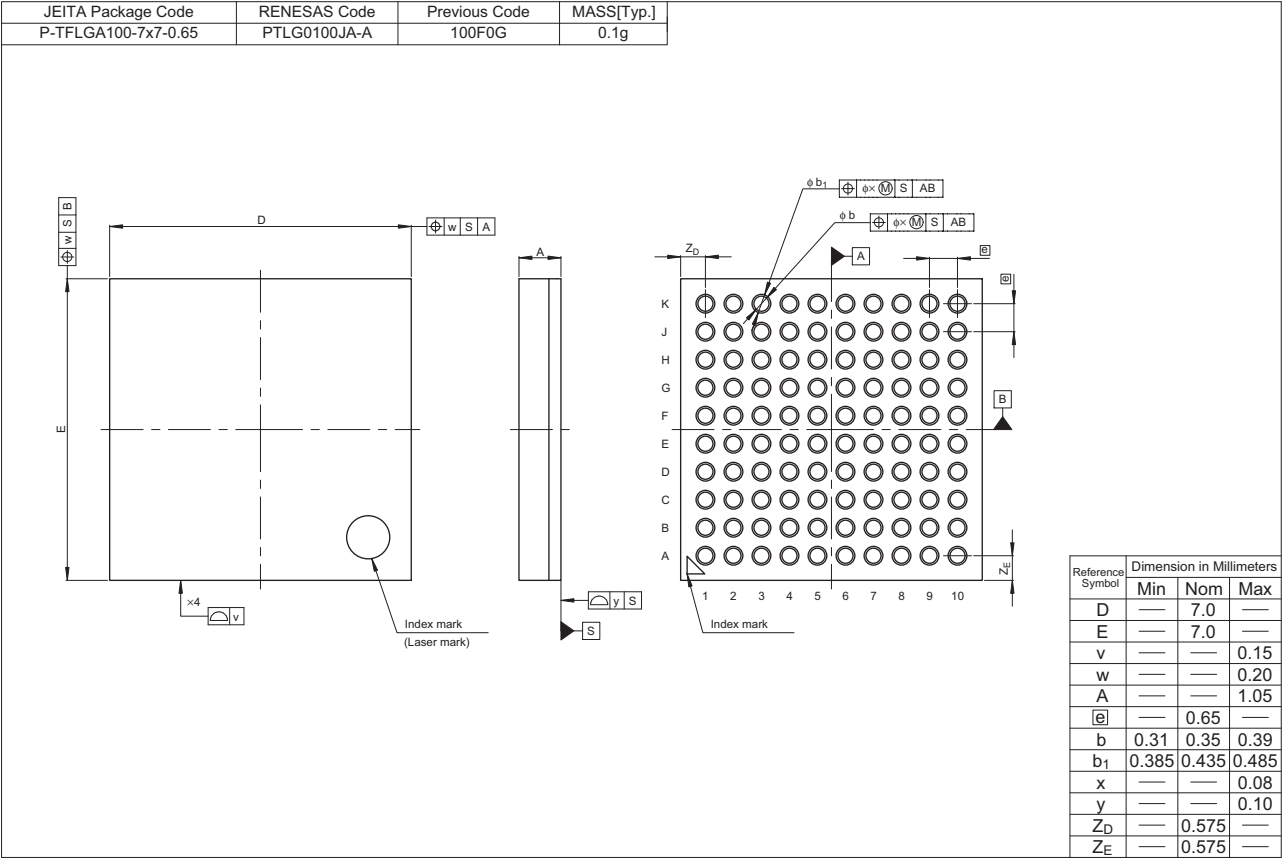


Figure B 100-Pin TFLGA (PTLG0100JA-A)

REVISION HISTORY	RX113 Group Datasheet
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Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev.	Date	Description		Classification
		Page	Summary	
1.02	Dec 01, 2014	—	First edition, issued	
1.10	Mar 31, 2016	1. Overview		
		16 to 23	Table 1.5 to 1.7 Note 2 regarding I/O power source is AVCC0 for the ports (P4, P9, PJ6, and P7), added	
		5. Electrical Characteristics		
		53	Table 5.1 Absolute Maximum Ratings, Analog power supply voltage added	TN-RX*-A149A/E
		54	Table 5.2 Recommended Operating Conditions, VREFH0 / VREFH / AVCC0 / VREFL added	TN-RX*-A149A/E
		60	Table 5.8 DC Characteristics (6), Increment for LPT operation and Increment for IWDG operation added	TN-RX*-A149A/E
		62	Table 5.9 DC Characteristics (7) added	TN-RX*-A136A/E
		62, 63	Table 5.10 DC Characteristics (8), LDV1,2 and CTSU operating current added	TN-RX*-A149A/E
		65, 66	Table 5.15 Permissible Output Currents is divided into D version and G version	TN-RX*-A136A/E
		105	Table 5.43 D/A Conversion Characteristics (1), Output voltage range added	
		119	Table 5.61 ROM (Flash Memory for Code Storage) Characteristics (2), Erasure time - 256-Kbyte added	TN-RX*-A132A/E
		120	Table 5.62 ROM (Flash Memory for Code Storage) Characteristics (3), Temperature range for the programming/erasure operation changed and Erasure time - 256-Kbyte added	TN-RX*-A132A/E
		121	Table 5.64 E2 DataFlash Characteristics (2), Low speed FCLK changed and Erasure time - 8-Kbyte added	TN-RX*-A132A/E
		121	Table 5.65 E2 DataFlash Characteristics (3), Temperature range for the programming/erasure operation changed, Low speed FCLK changed and Erasure time - 8-Kbyte added	TN-RX*-A132A/E
		122 to 124	5.15 Usage Notes added	